



High power cycling capability
Low on-state and switching losses
Designed for traction and industrial applications

Phase Control Thyristor Chip Type TG70-2000-18

Maximum allowable mean on-state current ¹⁾			I _{TAV}		2000 A	
Repetitive peak off-state voltage			V _{DRM}		1000...1800 V	
Repetitive peak reverse voltage			V _{R_{RM}}			
Turn-off time			t _q		250 μs	
V _{DRM} , V _{R_{RM}} , V	1000	1200	1400	1600	1800	
Voltage code	10	12	14	16	18	
T _j , °C	-60...+125					

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Maximum allowable mean on-state current ¹⁾	A	2000 2515 3114	$T_c = 96\text{ }^{\circ}\text{C}$, Double side cooled $T_c = 85\text{ }^{\circ}\text{C}$, Double side cooled $T_c = 70^{\circ}\text{C}$, Double side cooled 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current ¹⁾	A	3140	$T_c = 96\text{ }^{\circ}\text{C}$, Double side cooled 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current ¹⁾	kA	44.0 51.0	$T_j = T_{j\text{ max}}$ $T_j = 25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p = 10\text{ ms}$; single pulse; $V_D = V_R = 0\text{ V}$; Gate pulse: $I_G = 2\text{ A}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt \geq 1\text{ A}/\mu\text{s}$
			46.0 53.0	$T_j = T_{j\text{ max}}$ $T_j = 25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p = 8.3\text{ ms}$; single pulse; $V_D = V_R = 0\text{ V}$; Gate pulse: $I_G = 2\text{ A}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt \geq 1\text{ A}/\mu\text{s}$
I^2t	Safety factor ¹⁾	$\text{A}^2\text{s} \cdot 10^3$	9600 13000	$T_j = T_{j\text{ max}}$ $T_j = 25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p = 10\text{ ms}$; single pulse; $V_D = V_R = 0\text{ V}$; Gate pulse: $I_G = 2\text{ A}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt \geq 1\text{ A}/\mu\text{s}$
			8700 11600	$T_j = T_{j\text{ max}}$ $T_j = 25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p = 8.3\text{ ms}$; single pulse; $V_D = V_R = 0\text{ V}$; Gate pulse: $I_G = 2\text{ A}$; $t_{GP} = 50\text{ }\mu\text{s}$; $di_G/dt \geq 1\text{ A}/\mu\text{s}$
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000...1800	$T_{j\text{ min}} < T_j < T_{j\text{ max}}$; 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100...1900	$T_{j\text{ min}} < T_j < T_{j\text{ max}}$; 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j = T_{j\text{ max}}$; Gate open	

TRIGGERING				
I_{FGM}	Peak forward gate current	A	8	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	5	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	630	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 2 I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60...+50	
T_j	Operating junction temperature	$^{\circ}$ C	-60...+125	
MECHANICAL				
F	Mounting force ¹⁾	kN	33.0...40.0	
F_{cg}	Force on control gate	N	7.8	

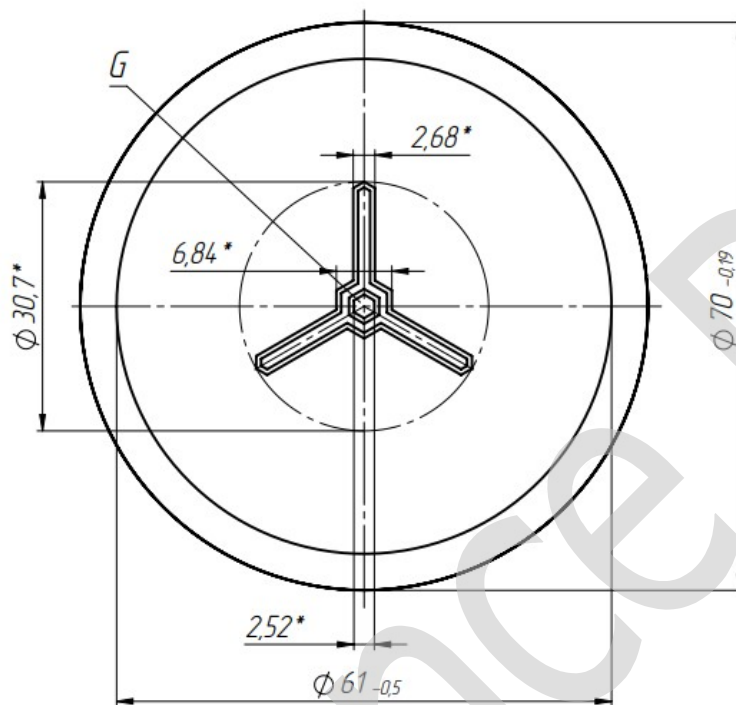
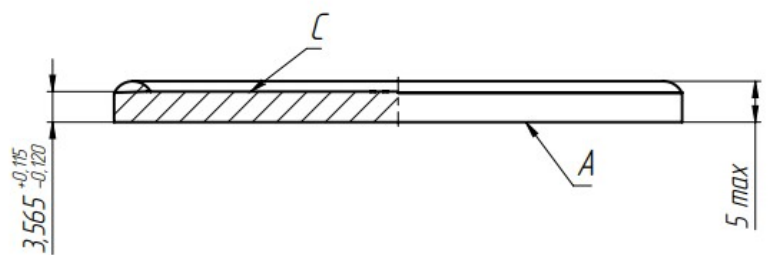
CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage ¹⁾ , max	V	1.45	$T_j=25\text{ }^{\circ}\text{C}$; $I_{TM}=5000\text{ A}$	
$V_{T(TO)}$	On-state threshold voltage, max	V	0.85	$T_j=T_{j\text{ max}}$;	
r_T	On-state slope resistance ¹⁾ , max	m Ω	0.120	$0.5\pi I_{TAV} < I_T < 1.5\pi I_{TAV}$	
I_L	Latching current, max	mA	1500	$T_j=25\text{ }^{\circ}\text{C}$; $V_D=12\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$	
I_H	Holding current, max	mA	300	$T_j=25\text{ }^{\circ}\text{C}$; $V_D=12\text{ V}$; Gate open	
BLOCKING					
I_{DRM} , I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	200	$T_j=T_{j\text{ max}}$; $V_D=V_{DRM}$; $V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ²⁾ , min	V/ μs	1000	$T_j=T_{j\text{ max}}$; $V_D=0.67\cdot V_{DRM}$; Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	5.00 3.00 2.00	$T_j= T_{j\text{ min}}$ $T_j=25\text{ }^{\circ}\text{C}$ $T_j= T_{j\text{ max}}$	$V_D=12\text{ V}$; $I_D=3\text{ A}$; Direct gate current
I_{GT}	Gate trigger direct current, max	mA	500 300 200	$T_j= T_{j\text{ min}}$ $T_j= 25\text{ }^{\circ}\text{C}$ $T_j= T_{j\text{ max}}$	
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j=T_{j\text{ max}}$; $V_D=0.67\cdot V_{DRM}$;	
I_{GD}	Gate non-trigger direct current, min	mA	15.00	Direct gate current	
SWITCHING					
t_{gd}	Delay time, max	μs	4.00	$T_j=25\text{ }^{\circ}\text{C}$; $V_D=0.4\cdot V_{DRM}$; $I_{TM}=I_{TAV}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$	
t_q	Turn-off time ³⁾ , max	μs	250	$dv_D/dt=50\text{ V}/\mu\text{s}$; $T_j=T_{j\text{ max}}$; $I_{TM}=2000\text{ A}$; $di_R/dt=-10\text{ A}/\mu\text{s}$; $V_R=100\text{ V}$; $V_D=0.67\text{ }V_{DRM}$;	

THERMAL					
R _{thjc}	Thermal resistance, junction to case ¹⁾ , max	°C/W	0.0100	Direct current	Double side cooled
R _{thjc-A}			0.0220		Anode side cooled
R _{thjc-K}			0.0180		Cathode side cooled
MECHANICAL					
m	Weight, max	g	168		

PART NUMBERING GUIDE						NOTES								
TG	70	2000	18	A2	M2	1) Depending on the specifications of the housing used. The specified values are relevant when using the Proton-Electrotex T.E3 housing. 2) Critical rate of rise of off-state voltage <table><tr><td>Symbol of Group</td><td>A2</td></tr><tr><td>$(dv_D/dt)_{crit}$, V/μs</td><td>1000</td></tr></table> 3) Turn-off time ($dv_D/dt=50$ V/μs) <table><tr><td>Symbol of Group</td><td>M2</td></tr><tr><td>t_{qf}, μs</td><td>250</td></tr></table>	Symbol of Group	A2	$(dv_D/dt)_{crit}$, V/ μ s	1000	Symbol of Group	M2	t_{qf} , μ s	250
Symbol of Group	A2													
$(dv_D/dt)_{crit}$, V/ μ s	1000													
Symbol of Group	M2													
t_{qf} , μ s	250													
1	2	3	4	5	6									
1. Phase Control Thyristor Chip with a distributed gate														
2. Maximum diameter, mm														
3. Mean on-state current, A														
4. Voltage code														
5. Critical rate of rise of off-state voltage, V/ μ s														
6. Turn-off time ($dv_D/dt=50$ V/ μ s)														

OVERALL DIMENSIONS



**Dimensions for reference .*

All dimensions in millimeters

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